



General Description

The MAX9938 high-side current-sense amplifier offers precision accuracy specifications of Vos less than 500µV (max) and gain error less than 0.5% (max). Quiescent supply current is an ultra-low 1µA. The MAX9938 fits in a tiny, 1mm x 1mm UCSP™ package size or a 5-pin SOT23 package, making the part ideal for applications in notebook computers, cell phones, PDAs. and all battery-operated portable devices where accuracy, low quiescent current, and small size are critical.

The MAX9938 features an input common-mode voltage range from 1.6V to 28V. These current-sense amplifiers have a voltage output and are offered in four gain versions: 25V/V (MAX9938T), 50V/V (MAX9938F), 100V/V (MAX9938H), and 200V/V (MAX9938W).

The four gain selections offer flexibility in the choice of the external current-sense resistor. The very low 500µV (max) input offset voltage allows small 25mV to 50mV full-scale VSENSE voltage for very low voltage drop at full-current measurement.

The MAX9938 is offered in tiny 4-bump, UCSP (1mm x 1mm x 0.6mm footprint), 5-pin SOT23, and 6-pin µDFN (2mm x 2mm x 0.8mm) packages specified for operation over the -40°C to +85°C extended temperature range.

Applications

Cell Phones

PDAs

Power Management Systems Portable/Battery-Powered Systems

Notebook Computers

Features

- ♦ Ultra-Low Supply Current of 1µA (max)
- ♦ Low 500µV (max) Input Offset Voltage
- ♦ Low < 0.5% (max) Gain Error
- ♦ Input Common Mode: +1.6V to +28V
- ♦ Voltage Output
- **♦ Four Gain Versions Available** 25V/V (MAX9938T) 50V/V (MAX9938F) 100V/V (MAX9938H) 200V/V (MAX9938W)
- ♦ Tiny 1mm x 1mm x 0.6mm, 4-Bump UCSP, 5-Pin SOT23, or 2mm x 2mm x 0.8mm, 6-Pin µDFN Packages

Ordering Information

PIN- PACKAGE	GAIN (V/V)	TOP MARK
4 UCSP	25	+AGD
4 UCSP	50	+AGE
4 UCSP	100	+AGF
4 UCSP	200	+AGI
5 SOT23	25	+AFFB
5 SOT23	50	+AFFC
5 SOT23	100	+AFFD
5 SOT23	200	+AFGZ
6 μDFN	50	+ACM
	PACKAGE 4 UCSP 4 UCSP 4 UCSP 4 UCSP 5 SOT23 5 SOT23 5 SOT23 5 SOT23	PACKAGE (V/V) 4 UCSP 25 4 UCSP 50 4 UCSP 100 4 UCSP 200 5 SOT23 25 5 SOT23 50 5 SOT23 100 5 SOT23 200

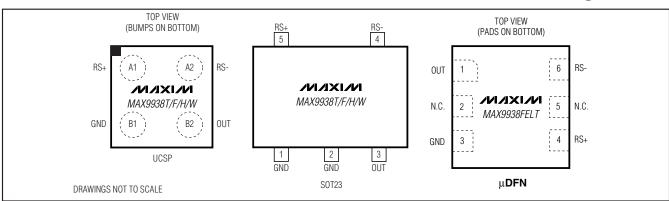
⁺Denotes a lead(Pb)-free/RoHS-compliant package.

G45 indicates protective die coating.

Note: All devices are specified over the -40°C to +85°C extended temperature range.

UCSP is a trademark of Maxim Integrated Products, Inc.

Pin Configurations



MIXIM

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ABSOLUTE MAXIMUM RATINGS

RS+, RS- to GND	0.3V to +30V
OUT to GND	0.3V to +6V
RS+ to RS	±30V
Short-Circuit Duration: OUT to GND	Continuous
Continuous Input Current (Any Pin)	±20mA
Continuous Power Dissipation (T _A = +70°C)
4-Bump UCSP (derate 3.0mW/°C above	
5-Pin SOT23 (derate 3.9mW/°C above +7	70°C)312mW
6-Pin µDFN (derate 4.5mW/°C above +70	0°C)358mW

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (excluding UCSP, soldering	g, 10s)+300°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{RS+} = V_{RS-} = 3.6V, V_{SENSE} = (V_{RS+} - V_{RS-}) = 0V, T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_{A} = +25^{\circ}C.) \text{ (Note 1)}$

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
		$V_{RS+} = 5V, T_A = +25^{\circ}C$;		0.5	0.85		
Cupply Current (Note 2)	la a	V _{RS+} = 5V, -40°C < T _A	< +85°C			1.1		
Supply Current (Note 2)	Icc	$V_{RS+} = 28V, T_A = +25^{\circ}C$			1.1	1.8	μΑ	
		V _{RS+} = 28V, -40°C < T _A < +85°C				2.5		
Common-Mode Input Range	V _{CM}	Guaranteed by CMRR	, -40°C < T _A < +85°C	1.6		28	V	
Common-Mode Rejection Ratio	CMRR	1.6V < V _{RS+} < 28V, -40	°C < T _A < +85°C	94	130		dB	
Input Offset Voltage (Note 3)	Vos	T _A = +25°C			±100	±500	/	
Imput Offset Voltage (Note 3)	VOS	-40°C < T _A < +85°C				±600	μV	
		MAX9938T			25			
Gain	G	MAX9938F			50		V/V	
Gairi	l G	MAX9938H			100] V/V	
		MAX9938W			200			
	GE	MAX9938T/MAX9938F/ MAX9938H	T _A = +25°C		±0.1	±0.5	%	
Gain Error (Noto 4)			-40°C < T _A < +85°C			±0.6		
Gain Error (Note 4)		MAX9938W	$T_A = +25^{\circ}C$		±0.1	±0.7		
		IVIAX9930VV	-40°C < T _A < +85°C			±0.8		
Output Resistance	Rout	(Note 5)	MAX9938T/F/H	7.0	10	13.2	$\left \begin{array}{cc} & \\ & k\Omega \end{array}\right $	
Output Hesistance	11001	(Note 3)	MAX9938W	14.0	20	26.4	1/22	
		Gain = 25			1.5	15		
OUT Low Voltage	Mar	Gain = 50			3	30	mV	
COT LOW Voltage	V _{OL}	Gain = 100			6	60		
		Gain = 200			12	120		
OUT High Voltage	VoH	V _{OH} = V _{RS-} - V _{OUT} (Note 6)			0.1	0.2	V	
Small-Signal Bandwidth (Note 5)		V _{SENSE} = 50mV, gain = 25			125			
	BW	V _{SENSE} = 50mV, gain = 50			60		kHz	
	DVV	V _{SENSE} = 50mV, gain = 100			30			
		V _{SENSE} = 50mV, gain = 200			15			
Output Settling Time	ts	1% final value, VSENSE	= 50mV		100		μs	

ELECTRICAL CHARACTERISTICS (continued)

(V_{RS+} = V_{RS-} = 3.6V, V_{SENSE} = (V_{RS+} - V_{RS-}) = 0V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

Note 1: All devices are 100% production tested at $T_A = +25$ °C. All temperature limits are guaranteed by design.

Note 2: Vout = 0. Icc is the total current into RS+ plus RS- pins.

Note 3: VOS is extrapolated from measurements for the gain-error test.

Note 4: Gain error is calculated by applying two values of V_{SENSE} and calculating the error of the slope vs. the ideal:

Gain = 25, V_{SENSE} is 20mV and 120mV.

Gain = 50, V_{SENSE} is 10mV and 60mV.

Gain = 100, VSENSE is 5mV and 30mV.

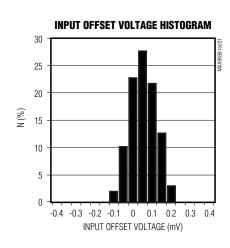
Gain = 200, V_{SENSE} is 2.5mV and 15mV.

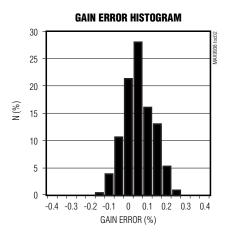
Note 5: The device is stable for any external capacitance value.

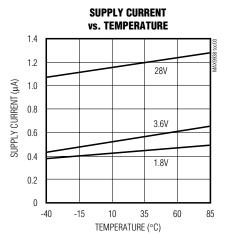
Note 6: VOH is the voltage from VRS- to VOUT with VSENSE = 3.6V/gain.

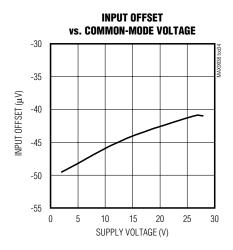
Typical Operating Characteristics

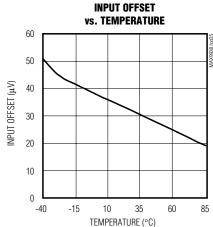
 $(V_{RS+} = V_{RS-} = 3.6V, T_A = +25$ °C, unless otherwise noted.)

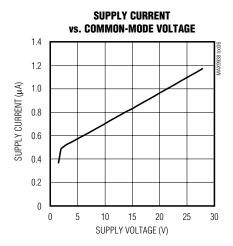






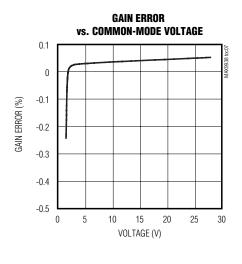


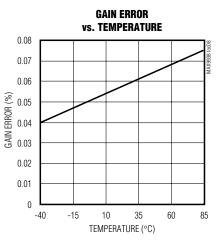


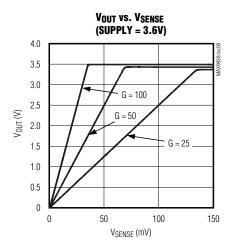


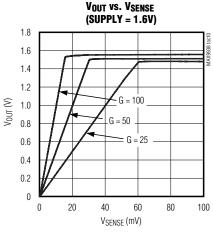
Typical Operating Characteristics (continued)

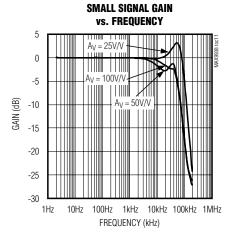
 $(V_{RS+} = V_{RS-} = 3.6V, T_A = +25^{\circ}C, unless otherwise noted.)$

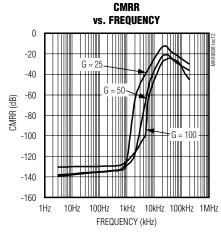


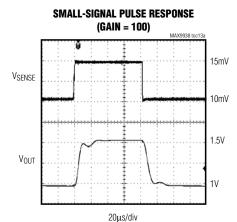


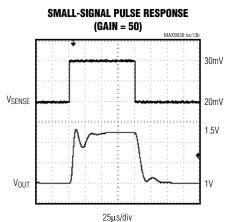








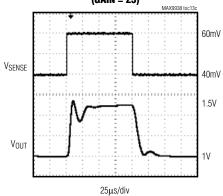




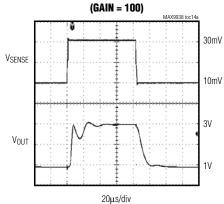
Typical Operating Characteristics (continued)

 $(V_{RS+} = V_{RS-} = 3.6V, T_A = +25^{\circ}C, unless otherwise noted.)$

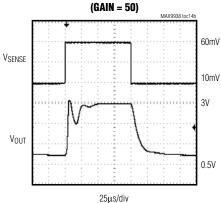
SMALL-SIGNAL PULSE RESPONSE (GAIN = 25)



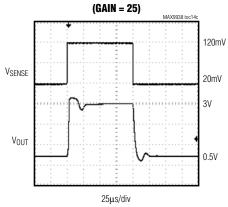
LARGE-SIGNAL PULSE RESPONSE



LARGE-SIGNAL PULSE RESPONSE



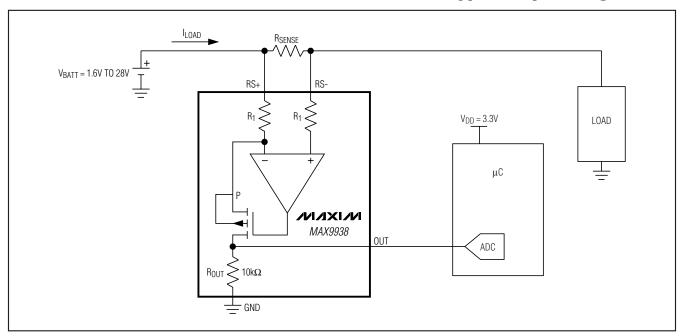
LARGE-SIGNAL PULSE RESPONSE



Pin Description

	PIN		NAME	FUNCTION	
UCSP	SOT23	μDFN	INAIVIE	FUNCTION	
A1	5	4	RS+	External Sense Resistor Power-Side Connection	
A2	4	6	RS-	External Sense Resistor Load-Side Connection	
B1	1, 2	3	GND	Ground	
B2	3	1	OUT	Output Voltage. VouT is proportional to Vsense = VRS+ - VRS	
_	_	2, 5	N.C.	No Connection. Not internally connected.	

Typical Operating Circuit



Detailed Description

The MAX9938 unidirectional high-side, current-sense amplifier features a 1.6V to 28V input common-mode range. This feature allows the monitoring of current out of a battery with a voltage as low as 1.6V. The MAX9938 monitors current through a current-sense resistor and amplifies the voltage across that resistor.

The MAX9938 is a unidirectional current-sense amplifier that has a well-established history. An op amp is used to force the current through an internal gain resistor at RS+, which has a value of R_1 , such that its voltage drop equals the voltage drop across an external sense resistor, RSENSE. There is an internal resistor at RS- with the

same value as R₁ to minimize offset voltage. The current through R₁ is sourced by a high-voltage p-channel FET. Its source current is the same as its drain current, which flows through a second gain resistor, R_{OUT}. This produces an output voltage, V_{OUT}, whose magnitude is I_{LOAD} x R_{SENSE} x R_{OUT}/R₁. The gain accuracy is based on the matching of the two gain resistors R₁ and R_{OUT} (see Table 1). Total gain = 25V/V for the MAX9938T, 50V/V for the MAX9938F, 100V/V for the MAX9938H, and 200V/V for the MAX9938W. The output is protected from input overdrive by use of an output current limiting circuit of 7mA (typical) and a 6V clamp protection circuit.

Table 1. Internal Gain Setting Resistors (Typical Values)

GAIN (V/V)	R ₁ (Ω)	$ extsf{R}_{ extsf{OUT}}$ ($ extsf{k}\Omega$)
200	100	20
100	100	10
50	200	10
25	400	10

Applications Information

Choosing the Sense Resistor

Choose RSENSE based on the following criteria:

Voltage Loss

A high RSENSE value causes the power-source voltage to drop due to IR loss. For minimal voltage loss, use the lowest RSENSE value.

OUT Swing vs. VRS+ and VSENSE

The MAX9938 is unique since the supply voltage is the input common-mode voltage (the average voltage at RS+ and RS-). There is no separate VCC supply voltage pin. Therefore, the OUT voltage swing is limited by the minimum voltage at RS+.

 $V_{OUT}(max) = V_{RS+} (min) - V_{SENSE} (max) - V_{OH}$ and

$$R_{SENSE} = \frac{V_{OUT}(max)}{G \times I_{LOAD}(max)}$$

VSENSE full scale should be less than VOUT/gain at the minimum RS+ voltage. For best performance with a 3.6V supply voltage, select RSENSE to provide approximately 120mV (gain of 25V/V), 60mV (gain of 50V/V), 30mV (gain of 100V/V), or 15mV (gain of 200V/V) of sense voltage for the full-scale current in each application. These can be increased by use of a higher minimum input voltage.

Accuracy

In the linear region ($V_{OUT} < V_{OUT}(max)$), there are two components to accuracy: input offset voltage (V_{OS}) and gain error (GE). For the MAX9938, $V_{OS} = 500\mu V$ (max) and gain error is 0.5% (max). Use the linear equation:

$$V_{OUT} = (gain \pm GE) \times V_{SENSE} \pm (gain \times V_{OS})$$

to calculate total error. A high RSENSE value allows lower currents to be measured more accurately because offsets are less significant when the sense voltage is larger.

Efficiency and Power Dissipation

At high current levels, the I²R losses in R_{SENSE} can be significant. Take this into consideration when choosing the resistor value and its power dissipation (wattage) rating. Also, the sense resistor's value might drift if it is allowed to heat up excessively. The precision V_{OS} of the MAX9938 allows the use of small sense resistors to reduce power dissipation and reduce hot spots.

Kelvin Connections

Because of the high currents that flow through RSENSE, take care to eliminate parasitic trace resistance from causing errors in the sense voltage. Either use a four-terminal current-sense resistor or use Kelvin (force and sense) PCB layout techniques.

Optional Output Filter Capacitor

When designing a system that uses a sample-and-hold stage in the ADC, the sampling capacitor momentarily loads OUT and causes a drop in the output voltage. If sampling time is very short (less than a microsecond), consider using a ceramic capacitor across OUT and GND to hold VOUT constant during sampling. This also decreases the small-signal bandwidth of the current-sense amplifier and reduces noise at OUT.

Input Filters

Some applications of current-sense amplifiers need to measure currents accurately even in the presence of both differential and common-mode ripple, as well as a wide variety of input transient conditions. For example, high-frequency ripple at the output of a switching buck or boost regulator results in a common-mode voltage at the inputs of the MAX9938. Alternatively, fast load-current transients, when measuring at the input of a switching buck or boost regulator, can cause high-frequency differential sense voltages to occur at the inputs of the MAX9938, although the signal of interest is the average DC value. Such high-frequency differential sense voltages may result in a voltage offset at the MAX9938 output.

The MAX9938 allows two methods of filtering to help improve performance in the presence of input common-mode voltage and input differential voltage transients. Figure 1 shows a differential input filter.

The capacitor CIN between RS+ and RS- along with the resistor RIN between the sense resistor and RS- helps filter against input differential voltages and prevents them from reaching the MAX9938.

The corner frequency of this filter is determined by the choice of RIN, CIN, and the value of the input resistance at RS- (R_1) . See Table 1 for R_1 values at the different gain options.

The value of RIN should be chosen to minimize its effect on the input offset voltage due to the bias current at RS-. RIN x IBIAS contributes to the input voltage offset. IBIAS is typically 0.2µA.

Placing RIN at the RS- input does not affect the gain error of the device because the gain is given by the ratio between ROUT and R1 at RS+.

Figure 2 shows the input common-mode filter.

Again, the corner frequency of the filter is determined by the choice of R_{IN} , C_{IN} and is affected by R_1 .

In this case R_{IN} affects both gain error and input offset voltage. R_{IN} should be smaller than R₁ so that it has negligible effect on the device gain. If, for example, a filter with R_{IN} = 10Ω and C_{IN} = 1μ F is built, then depending upon the gain selection, the gain error is affected by either 2.5% (G = 25V/V, R₁ = 400Ω) or 5% (G = 50V/V, R₁ = 200Ω) or 10% (G = 100V/V, R₁ = 100Ω) or 10% (G = 100V/V, R₁ = 100Ω).

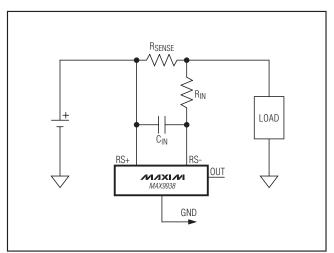


Figure 1. Differential Input Filter

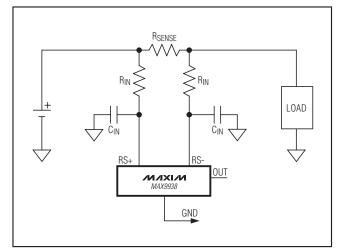


Figure 2. Input Common-Mode Filter

Bidirectional Application

Battery-powered systems may require a precise bidirectional current-sense amplifier to accurately monitor the battery's charge and discharge currents. Measurements of the two separate outputs with respect to GND yields an accurate measure of the charge and discharge currents respectively (Figure 3).

UCSP Applications Information

For the latest application details on UCSP construction, dimensions, tape carrier information, PCB techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, refer to the Application Note 1891: Wafer-Level Packaging (WLP) and Its Applications available on Maxim's website at www.maxim-ic.com/ucsp.

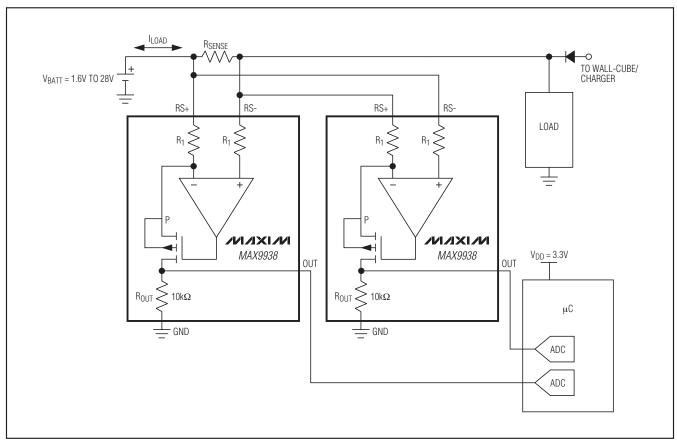


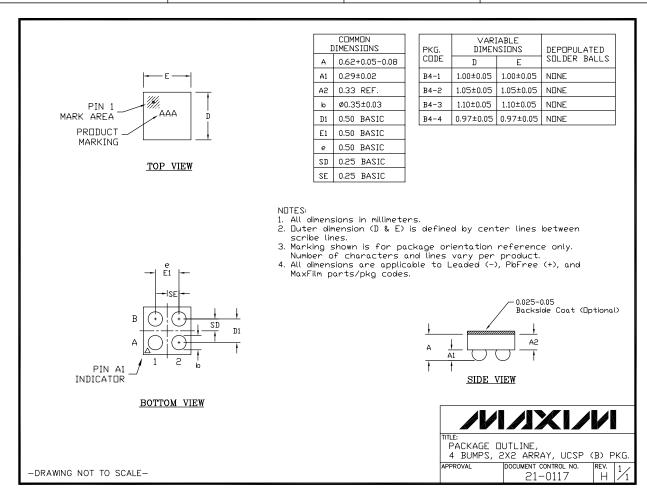
Figure 3. Bidirectional Application

_____Chip Information
PROCESS: BiCMOS

Package Information

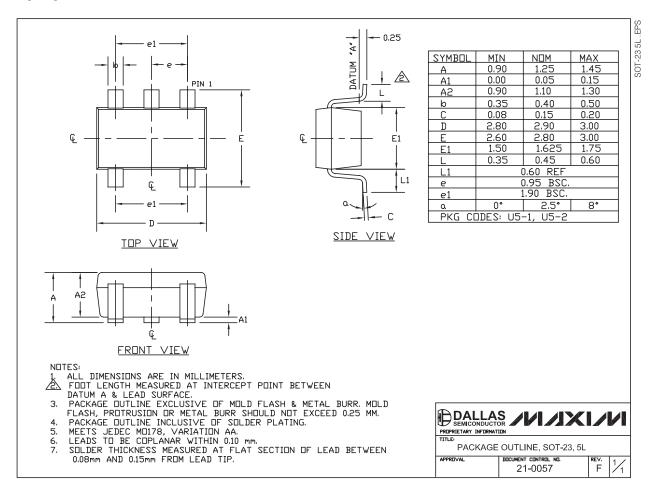
For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
2 x 2 UCSP	B4+1	<u>21-0117</u>	_
5 SOT23	U5-2	<u>21-0057</u>	<u>90-0174</u>
6 μDFN	L622+1	<u>21-0164</u>	<u>90-0004</u>



Package Information (continued)

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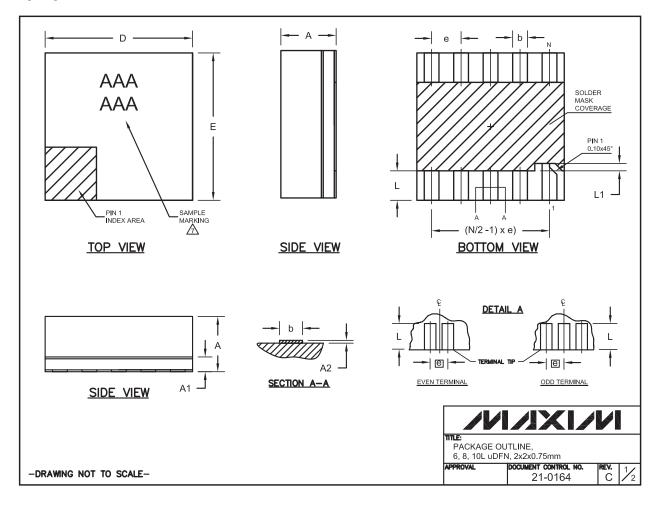


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1μA, 4-Bump UCSP/SOT23, Precision Current-Sense Amplifier

Package Information (continued)

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Package Information (continued)

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COMMON DIMENSIONS						
SYMBOL	MIN.	MIN. NOM. MAX.				
Α	0.70	0.75	0.80			
A1	0.15	0.20	0.25			
A2	0.020	0.025	0.035			
D	1.95	2.00	2.05			
E	1.95	2.00	2.05			
L	0.30	0.40	0.50			
L1	0.10 REF.					

PACKAGE VARIATIONS					
PKG. CODE	N	е	b	(N/2 -1) x e	
L622-1	6	0.65 BSC	0.30±0.05	1.30 REF.	
L822-1	8	0.50 BSC	0.25±0.05	1.50 REF.	
L1022-1	10	0.40 BSC	0.20±0.03	1.60 REF.	

- 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
- 2. COPLANARITY SHALL NOT EXCEED 0.08mm.
- 3. WARPAGE SHALL NOT EXCEED 0.10mm.
 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).

- 5. "N" IS THE TOTAL NUMBER OF LEADS.
 6. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.

 AMARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- 8. ONLY 8L PACKAGE COMPLIES TO JEDEC MO252.
- 9. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PEFREE (+) PACKAGE CODES.
- 10. LEAD PLATING MATERIAL: GOLD, 0.5 MICROMETER MINIMUM THICKNESS.

TITLE: PACKAGE OUTLINE, 6, 8, 10L uDFN, 2x2x0.75mm DOCUMENT CONTROL NO. 21-0164

-DRAWING NOT TO SCALE-

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/08	Initial release	_
1	9/08	Added µDFN package information	1, 2, 4, 5, 9
2	2/09	Added G45 designation to part number	1
3	10/09	Added Input Filters section and MAX9938W to the data sheet	1, 2, 6–9
4	2/10	Updated EC table and Input Filters section	2, 8
5	8/10	Removed Power-Up Time parameter	2
6	1/11	Corrected error on Figure 2	8

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